

DO-41



Features

- 1.0 Watt Power Dissipation
- 3.3V - 100V Nominal Zener Voltage
- Standard V_Z Tolerance is 5%

Mechanical Data

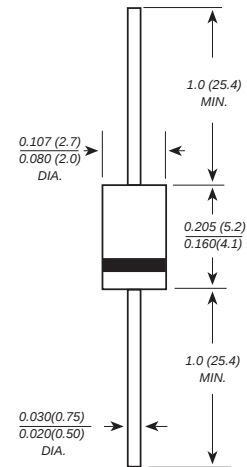
Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0088 ounce, 0.25 grams



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Characteristic	Symbol	Value	Unit
Zener Current (see Table page 2)	I_Z	P_d / V_Z	mA
Power Dissipation Derate Above 50°C (Note 1)	P_d	1.0 6.67	W mW/°C
Thermal Resistance - Junction to Ambient Air	$R_{\theta JA}$	175	°C/W
Forward Voltage @ $I_F = 200$ mA	V_F	1.2	V
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to + 200	°C

Note: 1. Valid provided that leads are kept at T_L @ 50°C with lead length = 9.5mm (3/8") from case.

Type Number	Nominal Zener Voltage (Note 2)	Test Current	Maximum Zener Impedance (Note 3)			Maximum Reverse Leakage Current		Max Surge Current 8.3ms	Temperature Coefficient @ I_{ZT}
	$V_Z @ I_{ZT}$	I_{ZT}	$Z_{ZT} @ I_{ZT}$	$Z_{ZK} @ I_{ZK}$	I_{ZK}	I_R	@ V_R	I_{ZS}	
	(V)	(mA)	(Ω)	(Ω)	(mA)	(μA)	(V)	(mA)	%/°C
1N4728A	3.3	76	10	400	1.0	100	1.0	1380	-0.08 to -0.05
1N4729A	3.6	69	10	400	1.0	100	1.0	1260	-0.08 to -0.05
1N4730A	3.9	64	9.0	400	1.0	50	1.0	1190	-0.07 to -0.02
1N4731A	4.3	58	9.0	400	1.0	10	1.0	1070	-0.07 to -0.01
1N4732A	4.7	53	8.0	500	1.0	10	1.0	970	-0.03 to +0.04
1N4733A	5.1	49	7.0	550	1.0	10	1.0	890	-0.01 to +0.04
1N4734A	5.6	45	5.0	600	1.0	10	2.0	810	0 to +0.045
1N4735A	6.2	41	2.0	700	1.0	10	3.0	730	+0.01 to +0.055
1N4736A	6.8	37	3.5	700	1.0	10	4.0	660	+0.015 to +0.06
1N4737A	7.5	34	4.0	700	0.5	10	5.0	605	+0.02 to +0.065
1N4738A	8.2	31	4.5	700	0.5	10	6.0	550	0.03 to 0.07
1N4739A	9.1	28	5.0	700	0.5	10	7.0	500	0.035 to 0.075
1N4740A	10	25	7.0	700	0.25	10	7.6	454	0.04 to 0.08
1N4741A	11	23	8.0	700	0.25	5.0	8.4	414	0.045 to 0.08
1N4742A	12	21	9.0	700	0.25	5.0	9.1	380	0.045 to 0.085
1N4743A	13	19	10	700	0.25	5.0	9.9	344	0.05 to 0.085
1N4744A	15	17	14	700	0.25	5.0	11.4	304	0.055 to 0.09
1N4745A	16	15.5	16	700	0.25	5.0	12.2	285	0.055 to 0.09
1N4746A	18	14	20	750	0.25	5.0	13.7	250	0.06 to 0.09
1N4747A	20	12.5	22	750	0.25	5.0	15.2	225	0.06 to 0.09
1N4748A	22	11.5	23	750	0.25	5.0	16.7	205	0.06 to 0.095
1N4749A	24	10.5	25	750	0.25	5.0	18.2	190	0.06 to 0.095
1N4750A	27	9.5	35	750	0.25	5.0	20.6	170	0.06 to 0.095
1N4751A	30	8.5	40	1000	0.25	5.0	22.8	150	0.06 to 0.095
1N4752A	33	7.5	45	1000	0.25	5.0	25.1	135	0.06 to 0.095
1N4753A	36	7.0	50	1000	0.25	5.0	27.4	125	0.06 to 0.095
1N4754A	39	6.5	60	1000	0.25	5.0	29.7	115	0.06 to 0.095
1N4755A	43	6.0	70	1500	0.25	5.0	32.7	110	0.06 to 0.095
1N4756A	47	5.5	80	1500	0.25	5.0	35.8	95	0.06 to 0.095
1N4757A	51	5.0	95	1500	0.25	5.0	38.8	90	0.06 to 0.095
1N4758A	56	4.5	110	2000	0.25	5.0	42.6	80	0.06 to 0.095
1N4759A	62	4.0	125	2000	0.25	5.0	47.1	70	0.06 to 0.095
1N4760A	68	3.7	150	2000	0.25	5.0	51.7	65	0.06 to 0.095
1N4761A	75	3.3	175	2000	0.25	5.0	56.0	60	0.06 to 0.095
1N4762A	82	3.0	200	3000	0.25	5.0	62.2	55	—
1N4763A	91	2.8	250	3000	0.25	5.0	69.2	50	—
1N4764A	100	2.5	350	3000	0.25	5.0	76.0	45	—

Notes: 2. Measured under thermal equilibrium and dc (I_{ZT}) test conditions.

3. The Zener impedance is derived from the 60 Hz ac voltage which results when an ac current having an rms value equal to 10% of the Zener current (I_{ZT} or I_{ZK}) is superimposed on I_{ZT} or I_{ZK} . Zener impedance is measured at two points to insure a sharp knee on the breakdown curve and to eliminate unstable units.

Ratings And Characteristic Curves

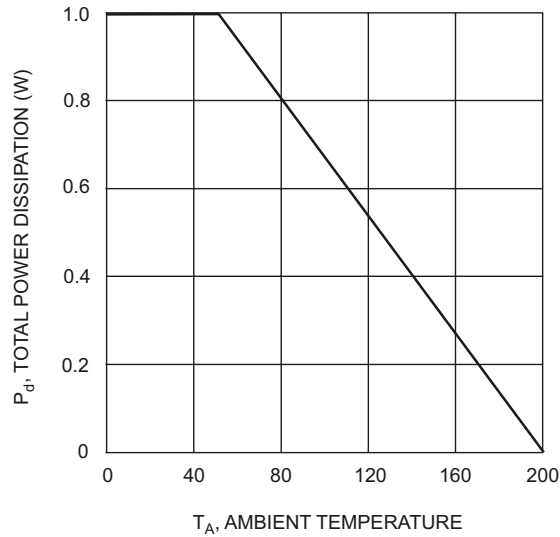


Fig.1 Power Dissipation vs Ambient Temperature

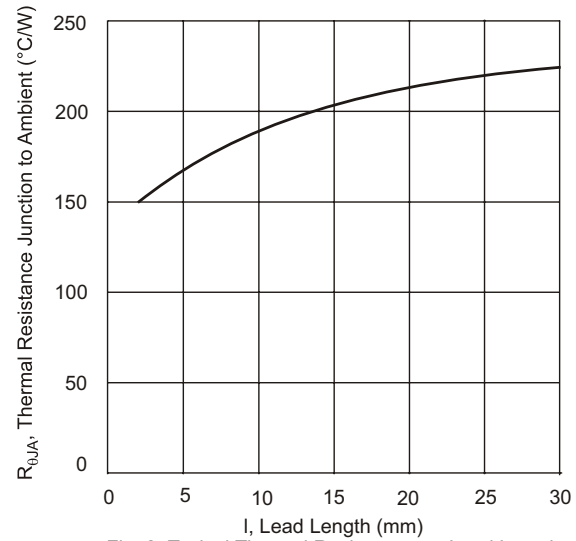


Fig.2 Typical Thermal Resistance vs. Lead Length

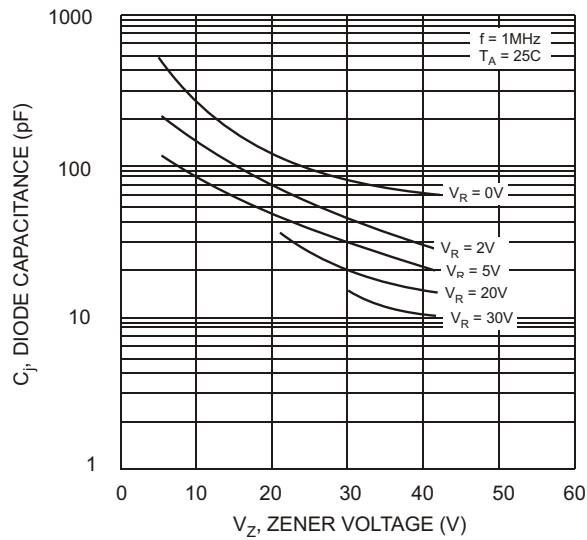


Fig.3, Junction Capacitance vs Zener Voltage

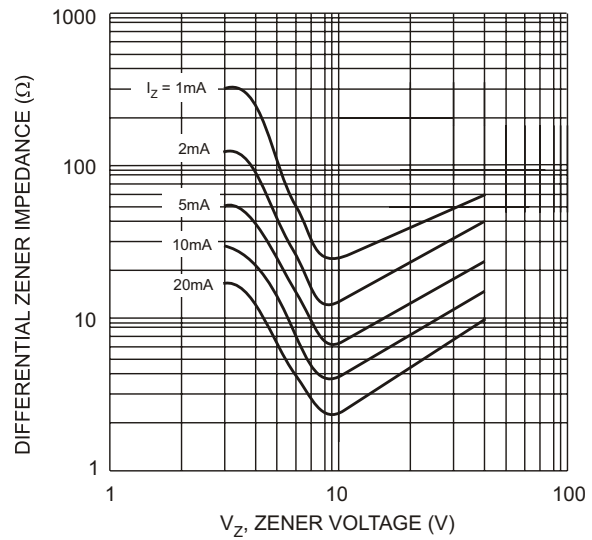
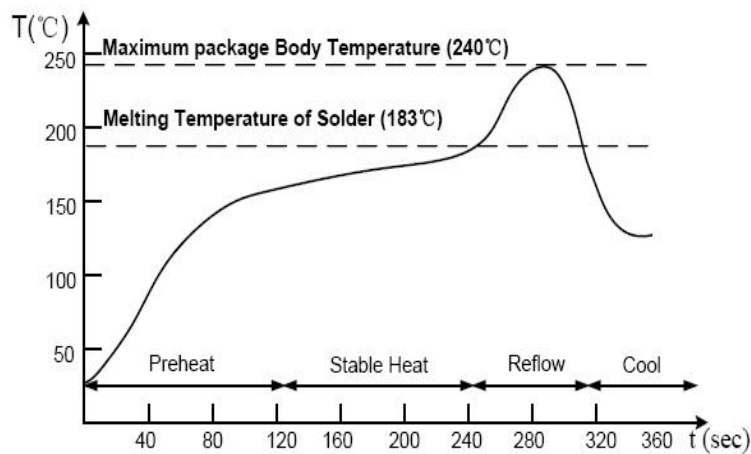


Fig.4 Typical Zener Impedance vs. Zener Voltage

Suggested Soldering Temperature Profile

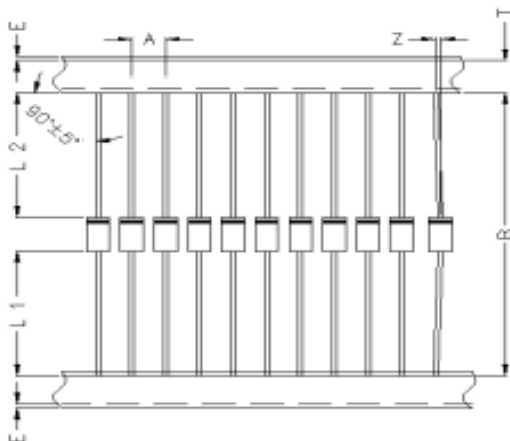


Note

- ◆ Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- ◆ The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- ◆ Devices can be cleaned using standard industry methods and solvents.
- ◆ If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Taping Specifications



Item	Symbol	Specifications(mm)
Component Pitch	A	5.0±0.5
Inner Tape Pitch	B	52.4±1.5
Component alignment	Z	1.2 Max
Tape width	T	6.0±0.5
Exposed adhesive	E	0.8 Max
Body eccentricity	L1-L2	1.0 Max

Ammunition Package Specifications

Package	Inner Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
DO - 41	255*150*75	5	420*276*312	50